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## Package : SON ×××V series

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#### 1.Structure and materials

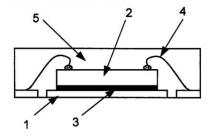


Fig. 1 Structure

#### 2. Tape and Reel information

2.1.Packing specification

Таре	Embossed carrier tape
Quantity	See the table on page 4/4
Direction of feed	E2(See Fig. 2)

2.2. Tape and Reel specification

2.2.1.Tape and reel dimensions (See the table on page 4/4)

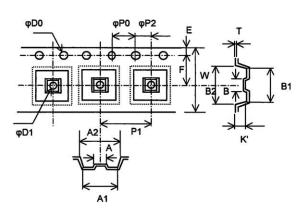


Fig. 3 Tape dimensions

No.	Item	Materials				
1	Lead Frame	Cu-Alloy (External lead : Pb free solder plating)				
2	Die	Silicon				
3	Die Attach	Ag Paste				
4	Wire	Au				
5	Molding	Epoxy Resin				

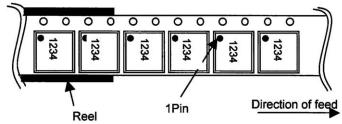


Fig. 2 Typical Tape and Reel configuration

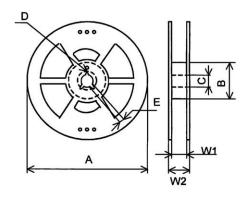


Fig. 4 Reel dimensions

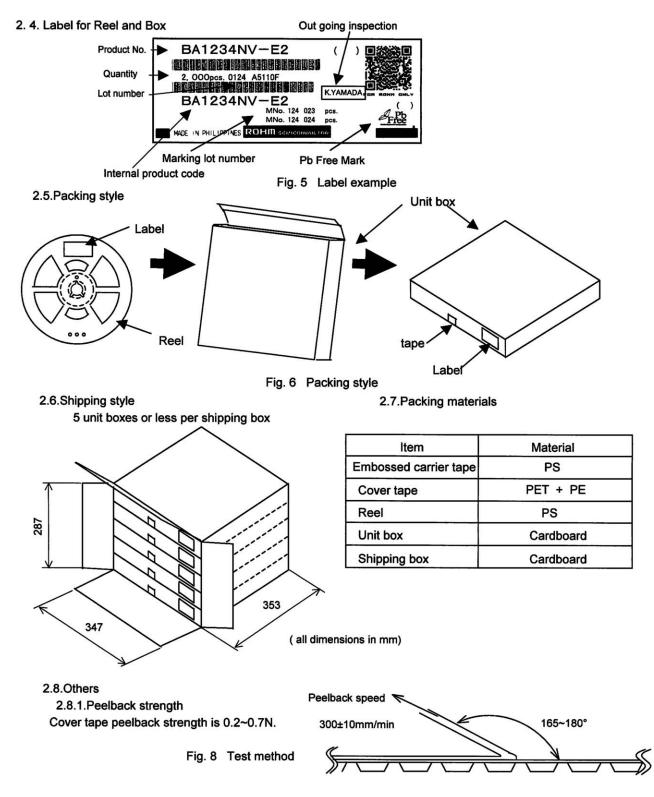
#### 2.3.Leader and Trailer

#### 2.3.1.Leader

No component pockets are 25 pockets or more.

#### 2.3.2.Trailer

No component pockets are 10 pockets or more. Tape is free from reel.



#### 2.8.2.Dropouts

(1)No consecutive dropouts.

(2)A maximun 0.1% of specified number of products in each packing may be missing.

: 5~30°C

:40~70% RH

#### 3.Storage conditions

3.1.Storage environment

Recommended storage conditions are as follows :

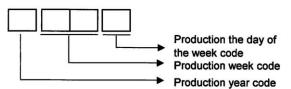
-Temperature

-Humidity

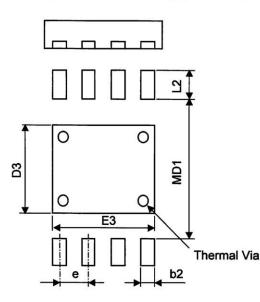
3.2.Storage period

-Specified storage period : 1year

#### 4.Marking lot number



5.Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)



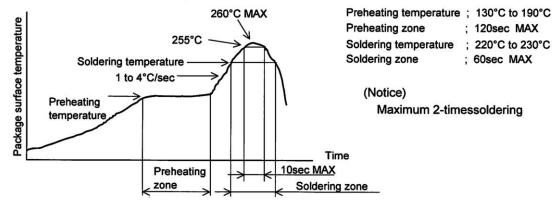
			(all dim	ensions in
Package	Land pitch e	Land space MD1	Land length ≥ L2	Land width b2
SON008V5060	1.27	4.20	1.20	0.42

Package	Radiaton land length	Radiaton land width	Thermal via	
T donugo	D3	E3	Pitch	Diameter
SON008V5060	3.20	4.10	1.20	<b>φ0.3</b>

\*The lead toe and lead side fillet may not be achieved because of non-lead packeges.

#### **6.Soldering conditions**

6.1.Recommended temperature profile for reflow

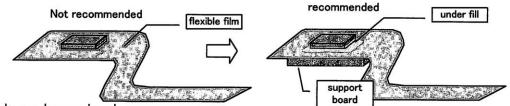


6.2. The wave soldering method is not supported.

- 6.3 Notice information of board mounting
  - Mounting on flexible film

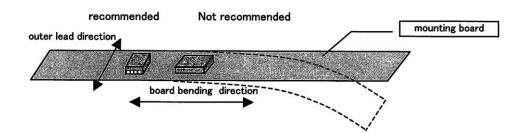
Mounting on flexible film, film bend may occur lack of lead from package,

usage of support board and under fill is recommended.

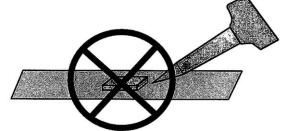


Mounting on long and narrow board

Mounting on long and narrow board, bending stress may occur a luck of lead from package, bending board direction and outer lead direction is recommended as drawing (vertically layout) and under fill usage is recommended.



6.4 Rework by solering iron is not allowed or it may cause mold crack and terminal open.



(Tape dimensions)

Packaga	Quantity			Ta	pe dimen	isions (a	ll dimens	ions in m	m)		
Package	(pcs)	Α	В	A1	B1	A2	B2	D0	D1	E	F
SON008V5060	2000	2.6	2.6	6.6	5.6	6.8	5.8	φ1.55	φ1.55	1.75	5.5
001100010000	2000	±0.2	±0.2	±0.1	±0.1	±0.2	±0.2	±0.05	±0.1	±0.1	±0.05

Paakaga	Та	Tape dimensions (all dimensions in mm)							
Package	K'	P0	P1	P2	Т	W			
SON008V5060	1.6	4.0	8.0	2.0	0.3	12.0			
301400875000	±0.1	±0.1	±0.1	±0.05	±0.05	±0.2			

<Reel dimensions >

Packaga	Reel dimensions (all dimensions in mm)						
Package	А	В	С	D	Е	W1	W2
SON008V5060	φ330	φ60	φ13.0	φ20.2	1.5	13.4	17.4
Tolerance	-	+1.0/0	±0.2	MIN	MIN	+1.0/0	±1.0

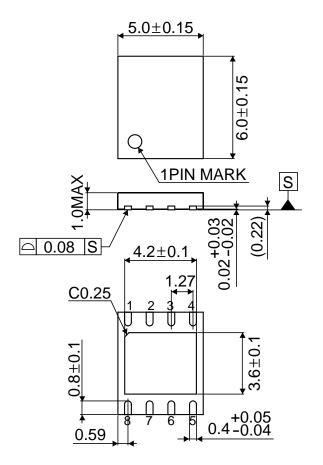
<Dehydrated weight >

Dehydrated weight
Dehydrated weight (g) 0.078
0.078



# Package Dimensions

SON008V5060



(Unit : mm)

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